

## SEK-18 SV MA LP STR55 PR-IN 20P PL2



Image is for illustration purposes only. Please refer to product description.

Part number	09 18 520 6329
Specification	SEK-18 SV MA LP STR55 PR-IN 20P PL2
HARTING eCatalogue	<a href="https://b2b.harting.com/09185206329">https://b2b.harting.com/09185206329</a>

### Identification

Category	Connectors
Series	SEK Low-profile
Element	Male connector
Description of the contact	Straight

### Version

Termination method	Press-in termination
Connection type	PCB to cable
Number of contacts	20
Termination length	5.5 mm
Performance level	2

### Technical characteristics

Contact rows	2
Contact spacing (termination side)	2.54 mm
Rated current	1 A
Insulation resistance	$>10^9 \Omega$
Contact resistance	$\leq 20 \text{ m}\Omega$
Limiting temperature	-55 ... +105 °C
Insertion and withdrawal force	$\leq 40 \text{ N}$
Mating cycles	$\geq 250$
Test voltage $U_{r.m.s.}$	1 kV
Isolation group	IIIa ( $175 \leq \text{CTI} < 400$ )



Pushing Performance

## Technical characteristics

PCB thickness	1.6 mm +1.6
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## Material properties

Material (insert)	Thermoplastic resin (PBT)
Colour (insert)	Grey
Material (contacts)	Copper alloy
Surface (contacts)	Nickel plated Termination side Au over Pd/Ni Mating side
Material flammability class acc. to UL 94	V-0
RoHS	compliant
ELV status	compliant
China RoHS	e
REACH Annex XVII substances	No
REACH ANNEX XIV substances	No
REACH SVHC substances	No

## Specifications and approvals

Specifications	IEC 60603-13
UL / CSA	UL 1977 ECBT2.E102079 CSA-C22.2 No. 182.3 ECBT8.E102079
Railway classification	F3/I3

## Commercial data

Packaging size	100
Net weight	2.34 g
Country of origin	Switzerland
European customs tariff number	85366990
eCl@ss	27440402 PCB connector



Pushing Performance

### Current carrying capacity

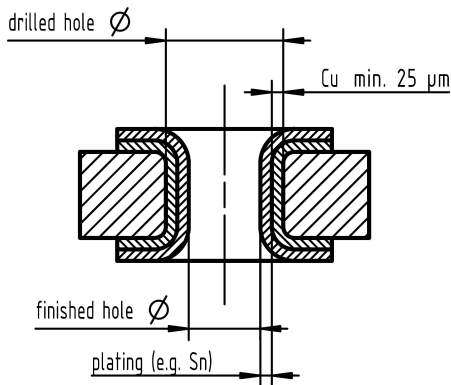
The current carrying capacity of the connectors is limited by the thermal load capability of the contact element material including the connections and the insulating parts. The derating curve is therefore valid for currents which flow constantly (non-intermittent) through each contact element of the connector evenly, without exceeding the allowed maximum temperature.

Measuring and testing techniques acc. to IEC 60512-5-2



- ① Temperature raise
- ② Derating curve
- ③ Derating curve 80%

Recommended configuration of plated through holes



Tin plated PCB (HAL) acc. to EN 60352-5	Drilled hole Ø	1,15-0,03 mm
	Cu	min. 25 µm
	Sn	max. 15 µm
	plated hole Ø	0,94 - 1,09 mm
Chemical tin plated PCB	Drilled hole Ø	1,15-0,03 mm
	Cu	min. 25 µm
	Sn	min. 0,8µm
	plated hole Ø	1,00 - 1,10 mm
Gold /Nickel plated PCB	Drilled hole Ø	1,15-0,03 mm
	Cu	min. 25 µm
	Ni	3 - 7 µm
	Au	0,05 - 0,12 µm
Silver plated PCB	Drilled hole Ø	1,15-0,03 mm
	Cu	min. 25 µm
	Ag	0,1 - 0,3 µm
	plated hole Ø	1,00 - 1,10 mm
Copper plated PCB (OSP)	Drilled hole Ø	1,15-0,03 mm
	Cu	min. 25 µm
	plated hole Ø	1,00 - 1,10 mm

In addition to the hot-air-level (HAL) other pcb surfaces are getting more important. Due to their different properties, such as mechanical strength and coefficient of friction we recommend the above mentioned configuration of pcb through holes.